SINGLE COMPONENT ADHESIVES

No Mixing, Measuring or Mess, Just Apply and Heat Cure

450°F - DURALCO™ 4420

Electrically Resistant Adhesive

Duralco[™] 4420 is ceramic filled and offers excellent electrical properties. No measuring, mixing or mess. Just apply and heat cure. (See table for cure cycles.)

Adheres to ceramics, glass, metals, plastics, mica, bond dissimilar materials, etc. and has excellent resistance to solvents, fuels, lubricants and most common chemicals.

Provides the low moisture absorption required for many electronic applications.

Users Report:

• Used for high speed production applications in the electrical electronics and appliance industries.

450°F - DURABOND™ 455

Thermally Conductive Structural Adhesive

Durabond $^{\mbox{\tiny M}}$ 445 is a one component, 100% solids, all purpose structural adhesive.

Filled with ultra fine, active Aluminum, Durabond $^{\rm \tiny M}$ 455 has the strength required for the most demanding applications.

Packaged in easy to use, 11 oz. dispenser tubes. Just apply and cure. (See table for cure cycles.)

Bonds to most metals, plastics, high performance composites, glass, ceramics, dissimilar materials, etc.

Use this unique system for high bond strength, high temp. stability, thermal shock resistance, chemical resistance, low shrinkage and machinability.

Applications Include: high performance bonding and assembling in appliances, aerospace, automotive, sports equipment, bonding dissimilar materials and eliminating brazing.

Cat. No. Description

Durabond 455-1..... 11 oz. Dispenser Tube

450°F - DURALCO™ 126 Electrically Conductive Structural Adhesive

Duralco[™] 126 Conductive Adhesive has the conductivity required for many high temperature electronic and industrial applications.

This ultra temp., one component adhesive combines Cotronics' unique resins and hardeners with specialty conductive fillers to provide continuous service up to 450°F.

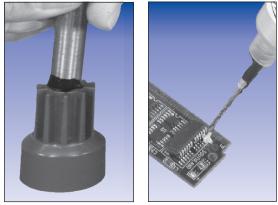
Specially designed for production applications and ideal for use in automatic dispensing equipment.

Applications Include: solder replacement, semi-conductor bonding, shielding, electronics, circuit board repair, etc.

Cat. No.		Description	
Duralco™	126-1	.2 oz.	Jar



Single Component Adhesive in Ready to Use 4 oz. and 11 oz. Caulking Tubes



Assembling a Dip Stick and a Circuit Board

Physical Properties	455	4420	126
Max. Use. Temperature	450°F	450°F	450°F
Mixed Density (gm/cc)	1.65	1.2	1.05
Hardness (Shore D)	80	75	75
Tensile Strength (psi)	10,000	7,000	10,000
Thermal Cond. (BTU-in/Hr. Ft ² °F)	12	8	50
Thermal Expansion (10 ⁻⁵ /°C)	6.40	3.3	6.40
Dielectric Strength (volts/mil)	400	400	500
Volume Resistivity (ohm-cm)	10 ¹⁰	10 ¹⁰	0.002
Heat Distortion (°C)	180	175	165
Mixed Viscosity (cps)	Paste	Paste	Smooth Fine Paste
Dissipation Factor (@100kc)	N/A	0.010	N/A
Dielectric Constant (@100kc)	N/A	3.8	N/A
Elongation (%)	1.00	1.5	1.40
Thermal Stability % (1000 hr. @ 200 °C)	0.8	0.6	0.8
Shrinkage (% max.)	0.2	0.3	0.5
Moisture Absorption (% 30 days @ 50 °C)	0.4	0.5	0.5
Components - Color	1-Gray	1-Gray	1-Silver
Cure (min @ 250°F)	30-60	30	30-60
(min @ 300°F)	5-30	5-30	15
(min @ 350°F)	3-15	3-15	10